

Description

The 74LVC1G86 is a single 2-input EXCLUSIVE OR gate with a standard push-pull output. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down.

The gate performs the positive Boolean function:

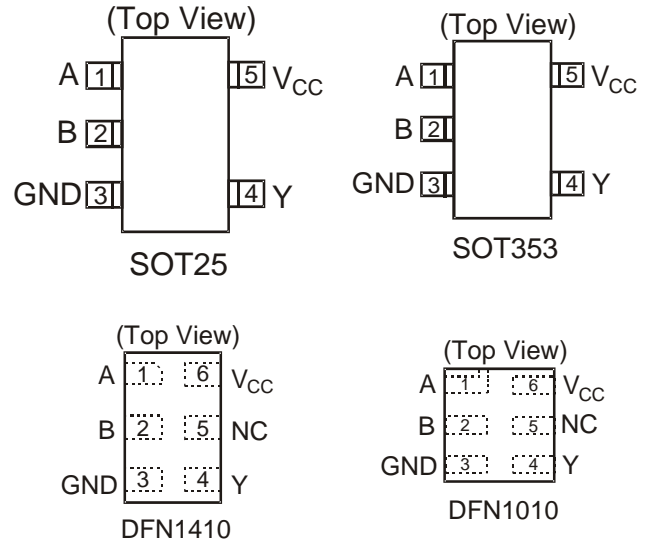
$$Y = A \oplus B \text{ or } Y = \overline{A}B + A\overline{B}$$

Features

- Wide Supply Voltage Range from 1.65 to 5.5V
- ± 24mA Output Drive at 3.3V
- CMOS low power consumption
- I_{OFF} Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Tested per JESD 22
 - Exceeds 200-V Machine Model (A115-A)
 - Exceeds 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- Range of Package Options
- Direct Interface with TTL Levels
- All packages Assembled with “Green” Molding Compound (no Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.

Pin Assignments



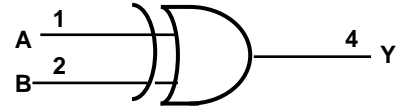
Applications

- Voltage Level Shifting
- Bus Driver / Repeater
- Parity Bit Generation
- Selectable signal Inverter
- Power Down Signal Isolation
- General Purpose Logic
- Wide array of products such as:
 - PCs, networking, notebooks, netbooks, PDAs
 - Tablet Computers, E-readers
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top box
 - Cell Phones, Personal Navigation / GPS
 - MP3 players ,Cameras, Video Recorders

Pin Descriptions

Pin Name	Description
A	Data Input
B	Data Input
GND	Ground
Y	Data Output
V _{CC}	Supply Voltage
NC	No Connection

Logic Diagram



Function Table

Inputs		Output
A	B	Y
H	H	L
L	H	H
H	L	H
L	L	L

Absolute Maximum Ratings (Note 2)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to 6.5	V
V _I	Input Voltage Range	-0.5 to 6.5	V
V _O	Voltage applied to output in high impedance or I _{OFF} state	-0.5 to 6.5	V
V _O	Voltage applied to output in high or low state.	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current V _I <0	-50	mA
I _{OK}	Output Clamp Current	-50	mA
I _O	Continuous output current	±50	mA
I _{CC} , I _{GND}	Continuous current through V _{CC} or GND	±100	mA
T _J	Operating Junction Temperature	-40 to 150	°C
T _{STG}	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 3)

Symbol	Parameter	Min	Max	Unit	
V _{CC}	Operating Voltage	Operating	1.65	5.5	V
		Data retention only	1.5		V
V _{IH}	High-level Input Voltage	V _{CC} = 1.65V to 1.95V	0.65 X V _{CC}		V
		V _{CC} = 2.3V to 2.7V	1.7		
		V _{CC} = 3V to 3.6V	2		
		V _{CC} = 4.5V to 5.5V	0.7 X V _{CC}		
V _{IL}	Low-level input voltage	V _{CC} = 1.65V to 1.95V		0.35 X V _{CC}	V
		V _{CC} = 2.3V to 2.7V		0.7	
		V _{CC} = 3V to 3.6V		0.8	
		V _{CC} = 4.5V to 5.5V		0.3 X V _{CC}	
V _I	Input Voltage	0	5.5	V	
V _O	Output Voltage	0	V _{CC}	V	
I _{OH}	High-level output current	V _{CC} = 1.65V		-4	mA
		V _{CC} = 2.3V		-8	
		V _{CC} = 3V		-16	
		V _{CC} = 4.5V		-24	
I _{OL}	Low-level output current	V _{CC} = 1.65V		4	mA
		V _{CC} = 2.3V		8	
		V _{CC} = 3V		16	
		V _{CC} = 4.5V		24	
Δt/ΔV	Input transition rise or fall rate	V _{CC} = 1.8V ± 0.15V, 2.5V ± 0.2V		20	ns/V
		V _{CC} = 3.3V ± 0.3V		10	
		V _{CC} = 5V ± 0.5V		5	
T _A	Operating free-air temperature	-40	125	°C	

Notes: 3. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (All typical values are at $V_{CC} = 3.3V$, $T_A = 25^\circ C$)

Symbol	Parameter	Test Conditions	Vcc	-40°C to 85°C			-40°C to 125°C		Unit
				Min	Typ.	Max	Min	Max	
V _{OH}	High Level Output Voltage	I _{OH} = -100μA	1.65V to 5.5V	V _{CC} - 0.1			V _{CC} - 0.1		V
		I _{OH} = -4mA	1.65V	1.2		0.95			
		I _{OH} = -8mA	2.3V	1.9		1.7			
		I _{OH} = -16mA	3V	2.4		2.2			
		I _{OH} = -24mA		2.3		2.0			
		I _{OH} = -32mA	4.5V	3.8		3.4			
V _{OL}	Low Level Output Voltage	I _{OL} = 100μA	1.65V to 5.5V			0.1	0.1	V	
		I _{OL} = 4mA	1.65V			0.45	0.7		
		I _{OL} = 8mA	2.3V			0.3	0.45		
		I _{OL} = 16mA	3V			0.4	0.6		
		I _{OL} = 24mA				0.55	0.8		
		I _{OL} = 32mA	4.5V			0.55	.8		
I _I	Input Current	V _I = 5.5 V or GND	0 to 5.5V		± 0.1	±5		± 100	μA
I _{OFF}	Power Down Leakage Current	V _I or V _O = 5.5V	0V			±10		±200	μA
I _{CC}	Supply Current	V _I = 5.5V or GND I _O =0	5.5V		0.1	10		200	μA
ΔI _{CC}	Additional Supply Current	One input at V _{CC} - 0.6V Other inputs at V _{CC} or GND	3V to 5.5V			500		5000	μA
C _i	Input Capacitance	V _I = V _{CC} - or GND	3.3V		5				pF

Package Characteristics (All typical values are at $V_{CC} = 3.3V$, $T_A = 25^\circ C$)

Symbol	Parameter	Test Conditions	V_{CC}	Min	Typ.	Max	Unit
θ_{JA}	Thermal Resistance Junction-to-Ambient	SOT25	(Note 4)		204		$^\circ C/W$
		SOT353			371		
		DFN1010			445		
		DFN1410			460		
θ_{JC}	Thermal Resistance Junction-to-Case	SOT25	(Note 4)		52		$^\circ C/W$
		SOT35			143		
		DFN1010			250		
		DFN1410			265		

Notes: 4. Test condition for SOT25, SOT353, DFN1410 and DFN1010: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Switching Characteristics

Figure 1 Typical Values at $T_A = 25^\circ C$ and nominal voltages 1.8V, 2.5V, 2.7V, 3.3V, and 5.0V.

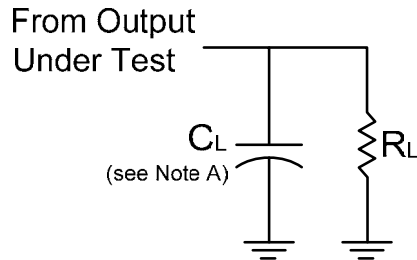
Parameter	From Input	To Output	V_{CC}	$T_A = -40^\circ C$ to $85^\circ C$			$T_A = -40^\circ C$ to $125^\circ C$		Unit
				Min	Typ.	Max	Min	Max	
t_{pd}	A or B	Y	$1.8V \pm 0.15V$	1.0	3.7	9.9	1.0	13.0	ns
			$2.5V \pm 0.2V$	0.5	2.5	5.5	0.5	7.0	
			2.7V	0.5	2.8	5.8	0.5	7.5	
			$3.3V \pm 0.3V$	0.5	2.3	5.0	0.5	6.5	
			$5.0V \pm 0.5V$	0.5	1.9	4.0	0.5	5.5	

Operating Characteristics

$T_A = 25^\circ C$

Parameter		Test Conditions	$V_{CC} = 1.8V$	$V_{CC} = 2.5V$	$V_{CC} = 3.3V$	$V_{CC} = 5V$	Unit
			Typ.	Typ.	Typ.	Typ.	
C_{pd}	Power dissipation capacitance	$f = 10$ MHz	14	14	14	14	pF

Parameter Measurement Information



V _{CC}	Inputs		V _M	C _L	R _L
	V _I	t _r /t _f			
1.8V ± 0.15V	V _{CC}	≤2ns	V _{CC} /2	30 pF	1 KΩ
2.5V ± 0.2V	V _{CC}	≤2ns	V _{CC} /2	30 pF	500 Ω
2.7V	V _{CC}	≤2.5ns	1.5V	50 pF	500 Ω
3.3V ± 0.3V	3.0V	≤2.5ns	1.5V	50 pF	500 Ω
5.0V ± 0.5V	V _{CC}	≤2.5ns	V _{CC} /2	50 pF	500 Ω

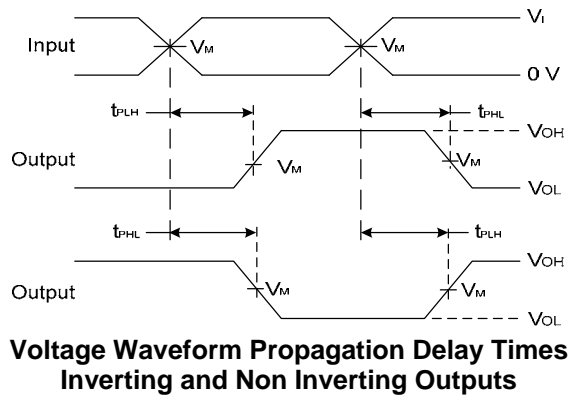
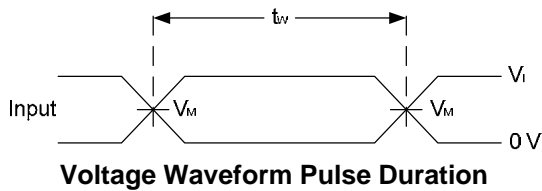
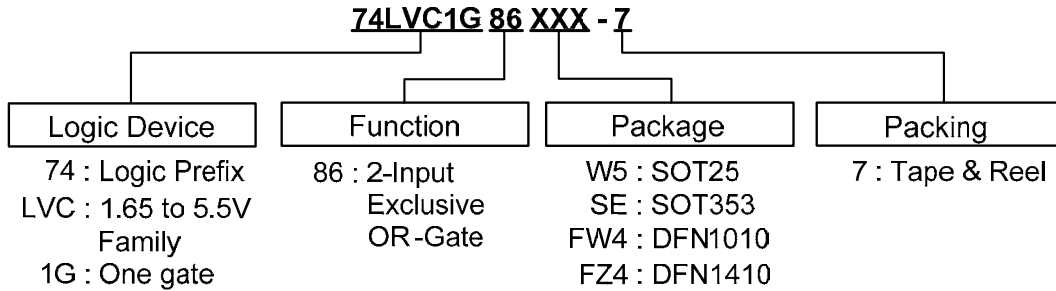


Figure 1. Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate ≤ 10 MHz.
 - C. Inputs are measured separately one transition per measurement.
 - D. t_{PLH} and t_{PHL} are the same as t_{PD}.

Ordering Information

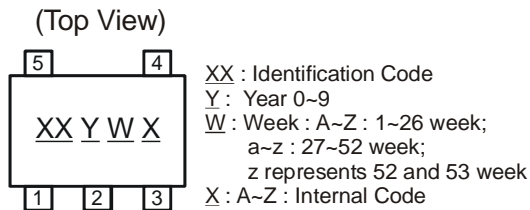


Device	Package Code	Packaging (Note 6)	7" Tape and Reel	
			Quantity	Part Number Suffix
74LVC1G86W5-7	W5	SOT25	3000/Tape & Reel	-7
74LVC1G86SE-7	SE	SOT353	3000/Tape & Reel	-7
74LVC1G86FW4-7	FW4	DFN1010	5000/Tape & Reel	-7
74LVC1G86FZ4-7	FZ4	DFN1410	5000/Tape & Reel	-7

Notes: 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>
 6. The taping orientation is located on our website at <http://www.diodes.com/datasheets/ap02007.pdf>

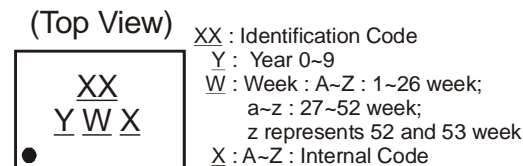
Marking Information

(1) SOT25 and SOT353



Part Number	Package	Identification Code
74LVC1G86W5	SOT25	UX
74LVC1G86SE	SOT353	UX

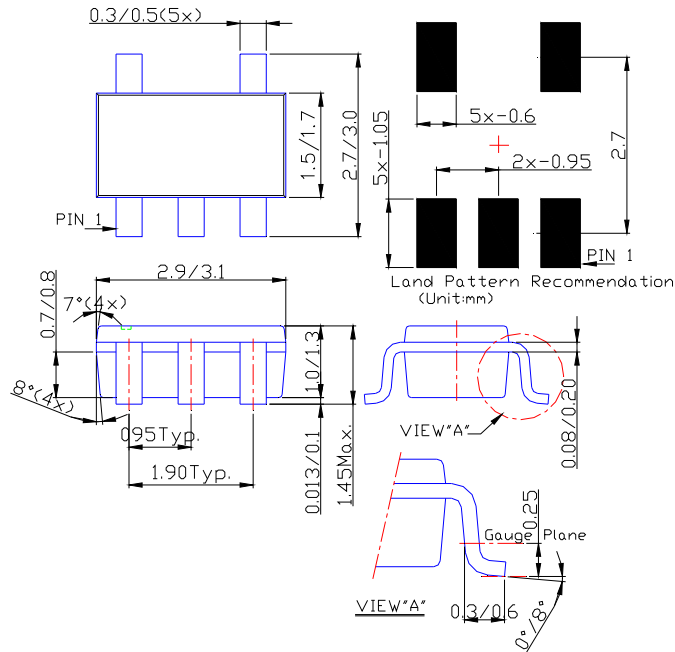
(3) DFN1010 and DFN1410



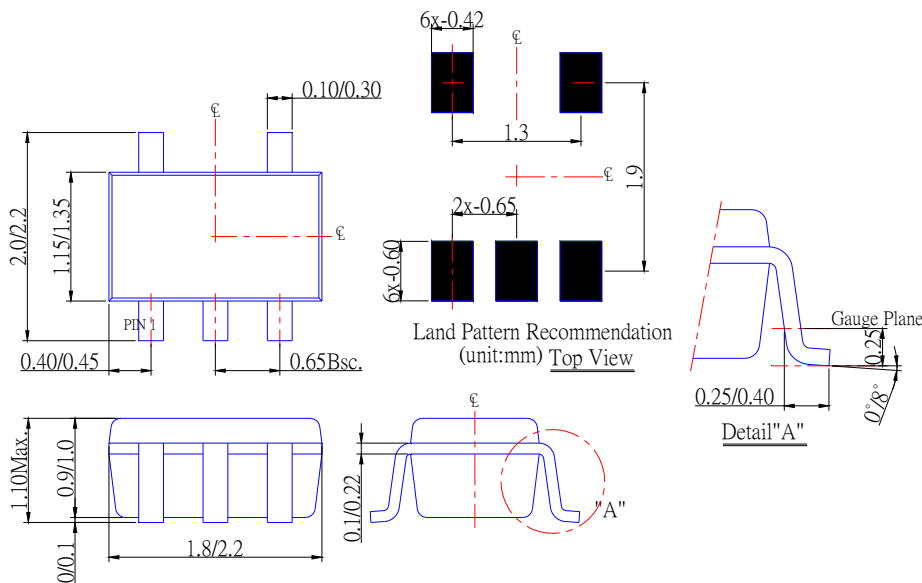
Part Number	Package	Identification Code
74LVC1G86FW4	DFN1010	UX
74LVC1G86FZ4	DFN1410	UX

Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: SOT25

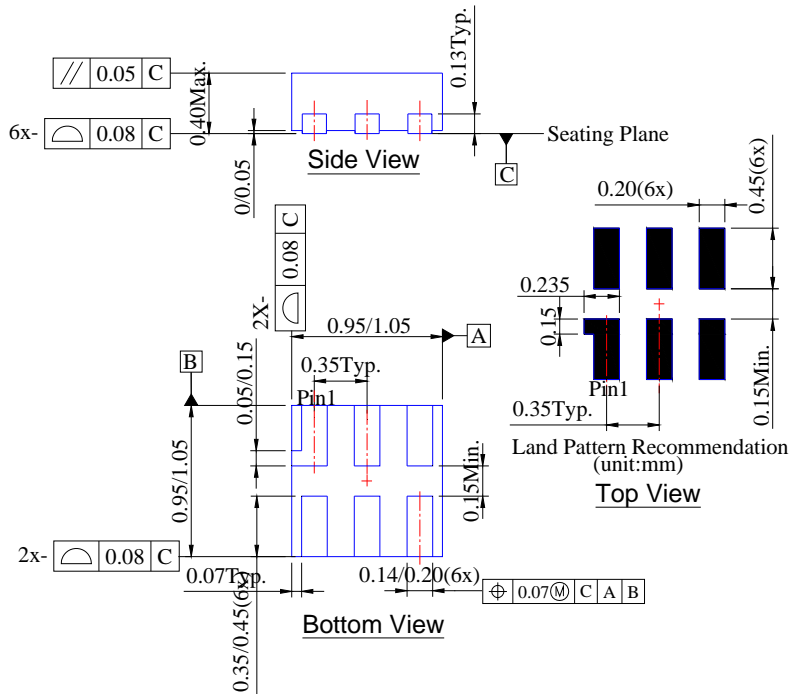


(2) Package Type: SOT353

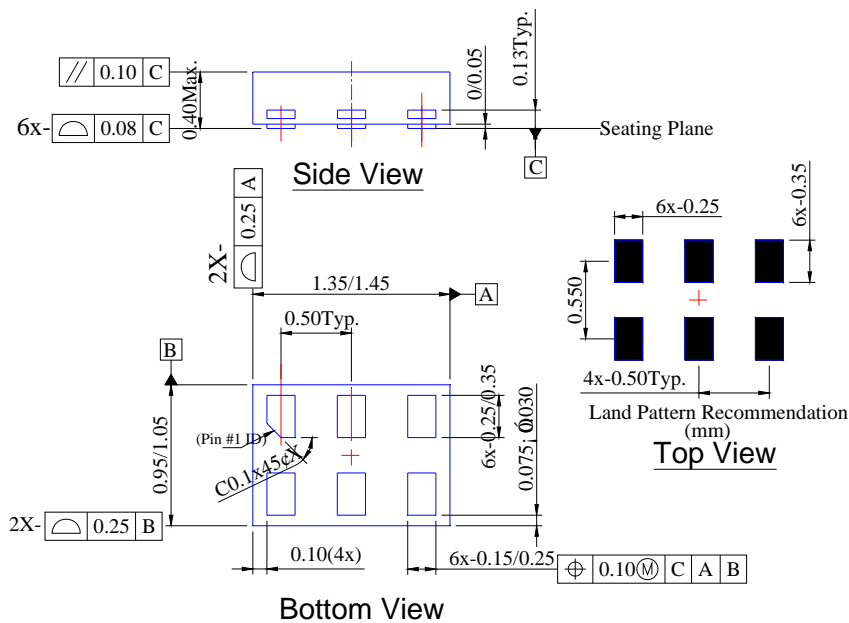


Package Outline Dimensions (cont.)

(3) Package Type DFN1010



(4) Package Type: DFN1410



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